

Announcements

**Fourth Workshop on Subsecond Thermophysics
German Aerospace Research Establishment
Köln, Germany
June 27–29, 1995**

This is the fourth in a series of recently established workshops on both experimental and theoretical aspects of thermophysical behavior of matter in the millisecond to picosecond time regimes. It will include both rapid resistive self-heating (volume) and pulse laser heating (surface) techniques. Emphasis will be on measurements at high temperatures. The workshop will consist of invited and contributed papers.

Abstracts (200–300 words) are to be submitted before December 1, 1994. The content of the abstract will be the basis for acceptance of the paper for presentation at the workshop. Papers are to be submitted by June 29, 1995. The papers will be reviewed and those accepted will be published in a Special Workshop Proceedings Issue of the *International Journal of Thermophysics*.

For further information, please contact

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**Fourth Asian Thermophysical Properties Conference
Keio University
Tokyo, Japan
September 5–8, 1995**

This is the fourth in the series of Asian Thermophysical Properties Conferences (ATPC), which was established in 1986. These conferences are

held at 3-year intervals in close cooperation with the Symposium on Thermophysical Properties in North America and the European Conferences on Thermophysical Properties.

The conference will cover thermophysical properties of solids and fluids, emphasizing both scientific aspects and engineering applications. The topics include thermodynamic, transport, thermal radiative, and other related properties, as well as databases, computer simulations, and new measurement techniques. The materials of interest include new materials (composites, thin films, FGMs), insulations, refrigerants, biological and agricultural materials, fluid mixtures, crystals and semiconductor materials, molten materials, plastics, ceramics, etc.

Abstracts (200–300 words in English) should be submitted to the conference chairman by February 15, 1995.

For further information please contact the conference chairman:

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